International Application No.: PCT/JP2005/009779

U.S. Patent Application No.: Unknown

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## **AMENDMENTS TO THE SPECIFICATION:**

A substitute specification and a marked-up copy of the English translation of the originally filed PCT application are attached hereto.

Please replace the Title of the Invention originally filed with the above-identified patent application with the following <u>new</u> Title:

METHOD FOR MANUFACTURING ELECTRONIC COMPONENTS, MOTHER SUBSTRATE, AND ELECTRONIC COMPONENT